

May 2007

74ACTQ14 Quiet Series™ Hex Inverter with Schmitt Trigger Input

Features

- I_{CC} reduced by 50%
- Guaranteed simultaneous switching noise level and dynamic threshold performance
- Improved latch-up immunity
- Guaranteed pin-to-pin skew AC performance
- Outputs source/sink 24mA

General Description

The ACTQ14 contains six inverter gates each with a Schmitt trigger input. They are capable of transforming slowly changing input signals into sharply defined, jitter-free output signals. In addition, they have a greater noise margin than conventional inverters.

The ACTQ14 utilizes Fairchild Quiet Series[™] Technology to guarantee quiet output switching and improve dynamic threshold performance. FACT Quiet Series[™] features GTO[™] output control and undershoot corrector in addition to a split ground bus for superior performance.

The ACTQ14 has hysteresis between the positive-going and negative-going input thresholds (typically 1.0V) which is determined internally by transistor ratios and is essentially insensitive to temperature and supply voltage variations.

Ordering Information

Order Number	Package Number	Package Description
74ACTQ14SC	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74ACTQ14MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

Connection Diagram



Inputs

Outputs

Logic Symbol



Function Table

Input (A)	Output (O)
L	Н
Н	L

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Description

Pin Descriptions
Pin Names

I_n

 \overline{O}_n

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	-0.5V to +7.0V
I _{IK}	DC Input Diode Current	
	$V_{I} = -0.5V$	–20mA
	$V_{I} = V_{CC} + 0.5V$	+20mA
VI	DC Input Voltage	–0.5V to V _{CC} + 0.5V
I _{OK}	DC Output Diode Current	
	$V_{O} = -0.5V$	–20mA
	$V_{O} = V_{CC} + 0.5V$	+20mA
V _O	DC Output Voltage	–0.5V to V _{CC} + 0.5V
Ι _Ο	DC Output Source or Sink Current	±50mA
I _{CC} or I _{GND}	DC V _{CC} or Ground Current per Output Pin	±50mA
T _{STG}	Storage Temperature	–65°C to +150°C
	DC Latch-Up Source or Sink Current	±300mA
TJ	Junction Temperature	

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	4.5V to 5.5V
VI	Input Voltage	0V to V _{CC}
Vo	Output Voltage	0V to V _{CC}
T _A	Operating Temperature	–40°C to +85°C

74ACTQ14 Quiet Series
Quiet S
eries TM
Hex
Inverter
with
I4 Quiet Series [™] Hex Inverter with Schmitt Trigger Input
Trigger
Input

DC Electrical Characteristics

				T _A =	+25°C	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	
Symbol	Parameter	V _{CC} (V)	Conditions	Тур	G	uaranteed Limits	Units
V _{IH}	Minimum HIGH Level	4.5	$V_{OUT} = 0.1V$	1.5	2.0	2.0	V
	Input Voltage	5.5	or V _{CC} – 0.1V	1.5	2.0	2.0	
V _{IL}	Maximum LOW Level	4.5	$V_{OUT} = 0.1V$	1.5	0.8	0.8	V
	Input Voltage	5.5	or V _{CC} – 0.1V	1.5	0.8	0.8	
V _{OH}	Minimum HIGH Level	4.5	Ι _{ΟUT} = -50μΑ	4.49	4.4	4.4	V
	Output Voltage	5.5		5.49	5.4	5.4	
			$V_{IN} = V_{IL} \text{ or } V_{IH}$:				
		4.5	$I_{OH} = -24mA$		3.86	3.76	
		5.5	$I_{OH} = -24 m A^{(1)}$		4.86	4.76	
V _{OL}	Maximum LOW Level	4.5	$I_{OUT} = 50 \mu A$	0.001	0.1	0.1	V
	Output Voltage	5.5		0.001	0.1	0.1	
			$V_{IN} = V_{IL} \text{ or } V_{IH}$:				
		4.5	$I_{OL} = 24mA$		0.36	0.44	
		5.5	$I_{OL} = 24 m A^{(1)}$		0.36	0.44	
I _{IN}	Maximum Input Leakage Current	5.5	$V_I = V_{CC}$, GND		±0.1	±1.0	μA
V _{h(max)}	Maximum Hysteresis	4.5	T _A = Worst Case		1.4	1.4	V
		5.5			1.6	1.6	
V _{h(min)}	Minimum Hysteresis	4.5	T _A = Worst Case		0.4	0.4	V
		5.5			0.5	0.5	
V _t +	Maximum Positive	4.5	T _A = Worst Case		2.0	2.0	V
	Threshold	5.5			2.0	2.0	
V _t -	Minimum Negative Threshold	4.5	T _A = Worst Case		0.8	0.8	V
		5.5			0.8	0.8	
I _{CCT}	Maximum I _{CC} /Input	5.5	$V_{I} = V_{CC} - 2.1V$	0.6		1.5	mA
I _{OLD}	Minimum Dynamic	5.5	V _{OLD} = 1.65V Max.			75	mA
I _{OHD}	Output Current ⁽²⁾	5.5	V _{OHD} = 3.85V Min.			-75	mA
I _{CC}	Maximum Quiescent Supply Current	5.5	$V_{IN} = V_{CC}$ or GND		2.0	20.0	μA
V _{OLP}	Quiet Output Maximum Dynamic V _{OL}	5.0	Figures 1 & 2 ⁽³⁾	1.1	1.5		V
V _{OLV}	Quiet Output Minimum Dynamic V _{OL}	5.0	Figures 1 & 2 ⁽³⁾	-0.6	-1.2		V
V _{IHD}	Minimum HIGH Level Dynamic Input Voltage	5.0	(4)	1.9	2.2		V
V _{ILD}	Maximum LOW Level Dynamic Input Voltage	5.0	(4)	1.2	0.8		V

Notes:

1. All outputs loaded; thresholds on input associated with output under test.

2. Maximum test duration 2.0ms, one output loaded at a time.

- 3. Max number of outputs defined as (n). Data inputs are 0V to 3V. One output @ GND.
- 4. Max number of data inputs (n) switching. (n–1) inputs switching 0V to 3V. Input-under-test switching: 3V to threshold (V_{ILD}), 0V to threshold (V_{ILD}), f = 1MHz.

AC Electrical Characteristics

			T ₄ C	ς = +25° ς_ = 50p	C, F	$ \begin{array}{c} T_A = -40^{\circ}C \\ C_L = \end{array} $	to +85°C, 50pF	
Symbol	Parameter	V _{CC} (V) ⁽⁵⁾	Min.	Тур.	Max.	Min.	Max.	Units
t _{PLH}	Propagation Delay, Data to Output	5.0	3.0	8.0	10.0	3.0	11.0	ns
t _{PHL}	Propagation Delay, Data to Output	5.0	3.0	8.0	10.0	3.0	11.0	ns
t _{OSHL} , t _{OSLH}	Output to Output Skew ⁽⁶⁾	5.0		0.5	1.0		1.0	ns

Notes:

5. Voltage range 5.0 is $5.0V \pm 0.5V$.

6. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}). Parameter guaranteed by design.

Capacitance

Symbol	Parameter	Conditions	Тур.	Units
C _{IN}	Input Capacitance	V _{CC} = OPEN	4.5	pF
C _{PD}	Power Dissipation Capacitance	$V_{CC} = 5.0V$	80	pF

FACT Noise Characteristics

The setup of a noise characteristics measurement is critical to the accuracy and repeatability of the tests. The following is a brief description of the setup used to measure the noise characteristics of FACT.

Equipment:

Hewlett Packard Model 8180A Word Generator

PC-163A Test Fixture

Tektronics Model 7854 Oscilloscope

Procedure:

- Verify Test Fixture Loading: Standard Load 50pF, 500Ω.
- 2. Deskew the HFS generator so that no two channels have greater than 150ps skew between them. This requires that the oscilloscope be deskewed first. It is important to deskew the HFS generator channels before testing. This will ensure that the outputs switch simultaneously.
- 3. Terminate all inputs and outputs to ensure proper loading of the outputs and that the input levels are at the correct voltage.
- Set the HFS generator to toggle all but one output at a frequency of 1MHz. Greater frequencies will increase DUT heating and effect the results of the measurement.



Notes:

- 7. V_{OHV} and V_{OLP} are measured with respect to ground reference.
- 8. Input pulses have the following characteristics: f = 1MHz, $t_r = 3ns$, $t_f = 3ns$, skew < 150ps.

Figure 1. Quiet Output Noise Voltage Waveforms

 Set the HFS generator input levels at 0V LOW and 3V HIGH for ACT devices and 0V LOW and 5V HIGH for AC devices. Verify levels with an oscilloscope.

V_{OLP}/V_{OLV} and V_{OHP}/V_{OHV}:

- Determine the quiet output pin that demonstrates the greatest noise levels. The worst case pin will usually be the furthest from the ground pin. Monitor the output voltages using a 50Ω coaxial cable plugged into a standard SMB type connector on the test fixture. Do not use an active FET probe.
- Measure V_{OLP} and V_{OLV} on the quiet output during the worst case transition for active and enable.
 Measure V_{OHP} and V_{OHV} on the quiet output during the worst case active and enable transition.
- Verify that the GND reference recorded on the oscilloscope has not drifted to ensure the accuracy and repeatability of the measurements.

V_{ILD} and V_{IHD}:

- Monitor one of the switching outputs using a 50Ω coaxial cable plugged into a standard SMB type connector on the test fixture. Do not use an active FET probe.
- First increase the input LOW voltage level, V_{IL}, until the output begins to oscillate or steps out a min of 2ns. Oscillation is defined as noise on the output LOW level that exceeds V_{IL} limits, or on output HIGH levels that exceed V_{IH} limits. The input LOW voltage level at which oscillation occurs is defined as V_{ILD}.
- Next decrease the input HIGH voltage level, V_{IH}, until the output begins to oscillate or steps out a min of 2ns. Oscillation is defined as noise on the output LOW level that exceeds V_{IL} limits, or on output HIGH levels that exceed V_{IH} limits. The input HIGH voltage level at which oscillation occurs is defined as V_{IHD}.
- Verify that the GND reference recorded on the oscilloscope has not drifted to ensure the accuracy and repeatability of the measurements.



Figure 2. Simultaneous Switching Test Circuit



Physical Dimensions (Continued)

Dimensions are in millimeters unless otherwise noted.





LAND PATTERN RECOMMENDATION





n.rttn.

1.00

DETAIL A

R0.09 min

0°-8'

12.00°TOP & BOTTOM

GAGE PLANE

0.25

SEATING PLANE

-R0.09min



- A. CONFORMS TO JEDEC REGISTRATION MD-153 VARIATION AB_ REF NOTE 6, DATED 7/93
- B. DIMENSIONS ARE IN MILLIMETERS
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS D. DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 1982

MTC14revD





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